



DFLS230L

2.0A SURFACE MOUNT SCHOTTKY BARRIER RECTIFIER PowerDI123

Features

- Guard Ring Die Construction for Transient Protection
- Low Power Loss, High Efficiency
- Patented Interlocking Clip Design for High Surge Current Capacity
- High Current Capability and Low Forward Voltage Drop
- Lead-Free Finish; RoHS Compliant (Notes 1 & 2)
- Halogen and Antimony Free. "Green" Device (Note 3)
- Qualified to AEC-Q101 Standards for High Reliability
- An Automotive-Compliant Part is Available Under Separate Datasheet (DFLS230LQ)

Mechanical Data

- Case: PowerDI[®]123
- Case Material: Molded Plastic, "Green" Molding Compound. UL Flammability Classification Rating 94V-0
- Moisture Sensitivity: Level 1 per J-STD-020
- Terminal Connections: Cathode Band
- Terminals: Finish Matte Tin Annealed Over Copper Leadframe. Solderable per MIL-STD-202, Method 208 (C3)
- Weight: 0.01 grams (Approximate)



Top View

Ordering Information (Note 4)

Part Number	Case	Packaging
DFLS230L-7	PowerDI123	3000/Tape & Reel

1. EU Directive 2002/95/EC (RoHS), 2011/65/EU (RoHS 2) & 2015/863/EU (RoHS 3) compliant. All applicable RoHS exemptions applied.

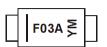
2. See https://www.diodes.com/quality/lead-free/ for more information about Diodes Incorporated's definitions of Halogen- and Antimony-free, "Green" and Lead-free.

3. Halogen- and Antimony-free "Green" products are defined as those which contain <900ppm bromine, <900ppm chlorine (<1500ppm total Br + Cl) and <1000ppm antimony compounds.

4. For packaging details, go to our website at https://www.diodes.com/design/support/packaging/diodes-packaging/.

Marking Information

Notes:



F03A = Product Type Marking Code YM = Date Code Marking Y = Year (ex: F = 2018) M = Month (ex: 9 = September)

Date Code Key												
Year	2004		~	2012	2013	20	14	2015	2016	20	17	2018
Code	R		~	Z	А		3	С	D	E	E	F
Month	Jan	Feb	Mar	Apr	Мау	Jun	Jul	Aug	Sep	Oct	Nov	Dec
Code	1	2	3	4	5	6	7	8	9	0	N	D

PowerDI is a registered trademark of Diodes Incorporated.



Maximum Ratings (@T_A = +25°C, unless otherwise specified.)

Single phase, half wave, 60Hz, resistive or inductive load.

For capa	citive load	, derate curre	nt by 20%.	

Characteristic	Symbol	Value	Unit
Peak Repetitive Reverse Voltage Working Peak Reverse Voltage DC Blocking Voltage	V _{RRM} V _{RWM} V _R	30	V
RMS Reverse Voltage	V _{R(RMS)}	21	V
Average Forward Current @ $T_T = +121^{\circ}C$	I _{F(AV)}	2.0	A
Non-Repetitive Peak Forward Surge Current 8.3ms Single Half Sine-Wave Superimposed on Rated Load	IFSM	33	А

Thermal Characteristics

Characteristic	Symbol	Value	Unit
Power Dissipation (Note 5)	PD	1.67	W
Power Dissipation (Note 6)	PD	556	mW
Thermal Resistance Junction to Ambient (Note 5)	$R_{ ext{ heta}JA}$	60	°C/W
Thermal Resistance Junction to Ambient (Note 6)	$R_{ heta JA}$	180	°C/W
Thermal Resistance Junction to Soldering (Note 7)	R ₀ JS	10	°C/W
Operating Temperature Range	TJ	-40 to +125	°C
Storage Temperature Range	T _{STG}	-40 to +150	°C

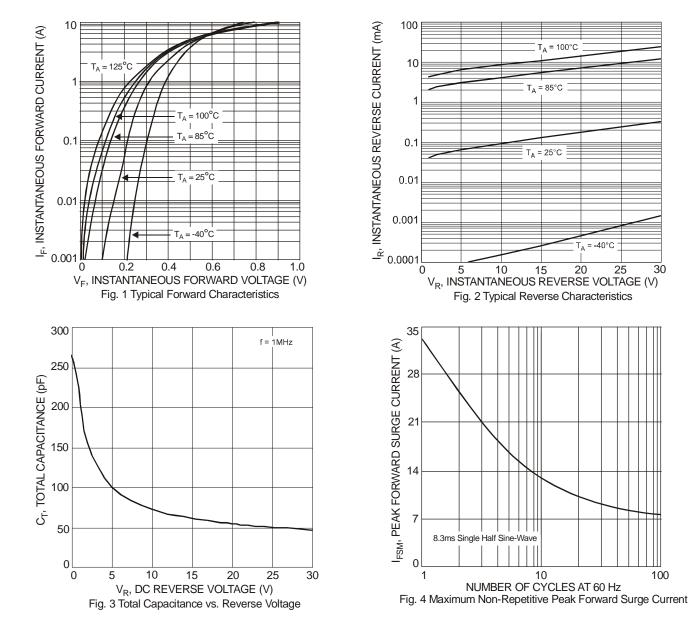
Electrical Characteristics (@T_A = +25°C, unless otherwise specified.)

Characteristic	Symbol	Min	Тур	Max	Unit	Test Condition
Reverse Breakdown Voltage (Note 8)	V _{(BR)R}	30	_	_	V	I _R = 1.0mA
Forward Voltage	VF	_	0.310	_	v	I _F = 1.0A
Forward Voltage	VF		0.375	0.420		$I_{F} = 2.0A$
Leakage Current (Note 8)	1-	_	0.260		mA	V _R = 5V, T _A = +25°C
Leakage Current (Note 6)	IR		_	1.0	ША	$V_R = 5V, T_A = +25^{\circ}C$ $V_R = 30V, T_A = +25^{\circ}C$
Total Capacitance	CT	_	76	_	pF	V _R = 10V, f = 1.0MHz

Notes: 5. Part mounted on 2"x2" GETEK board with 1"x1" copper pad, 25% anode, 75% cathode. $T_A = +25^{\circ}C$.

6. Part mounted on PR-4 board with recommended pad layout, which can be found on our website at http://www.diodes.com/package-outlines.html.
7. Theoretical R_{0JS} calculated from the top center of the die straight down to the PCB/cathode tab solder junction.
8. Short duration pulse test used to minimize self-heating effect.

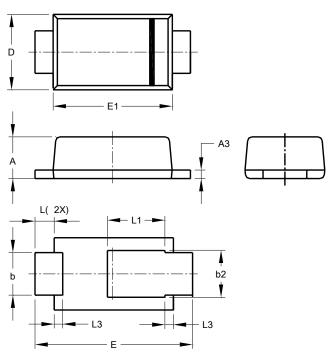






Package Outline Dimensions

Please see http://www.diodes.com/package-outlines.html for the latest version.

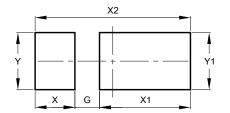


PowerDI123							
Dim	Min	Max	Тур				
Α	0.93	1.00	0.98				
A3	0.15	0.25	0.20				
b	0.85	1.25	1.00				
b2	1.025	1.125	1.10				
D	1.63	1.93	1.78				
E	3.50	3.90	3.70				
E1	2.60	3.00	2.80				
L	0.40	0.50	0.45				
L1	1.25	1.40	1.35				
L3	0.125	0.275	0.20				
All Dimensions in mm							

Suggested Pad Layout

Please see http://www.diodes.com/package-outlines.html for the latest version.

PowerDI123



Dimensions	Value (in mm)
G	0.65
Х	1.05
X1	2.40
X2	4.10
Y	1.50
Y1	1.50

PowerDI123



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